

# GU3KR-B-E

## SURFACE MOUNT FAST ULTRAFAST RECTIFIER

VOLTAGE: 800V

CURRENT: 3.0A

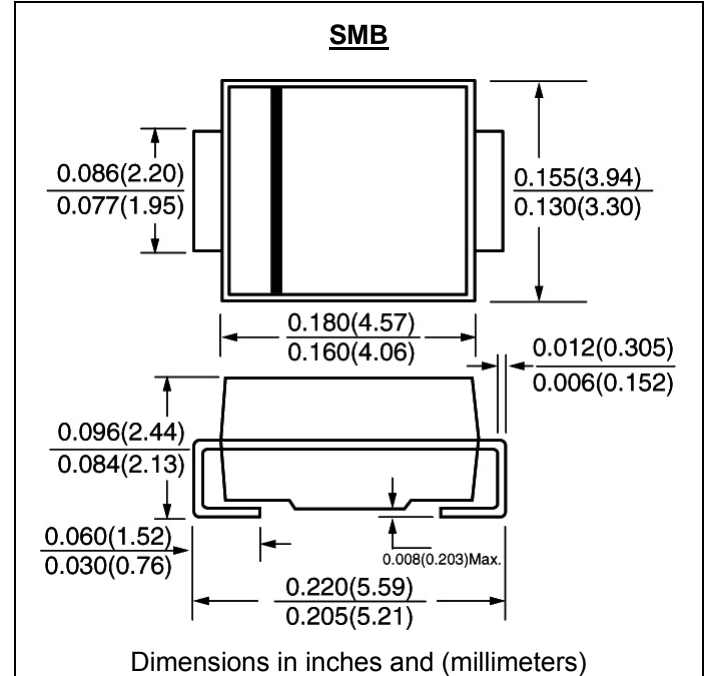


### FEATURE

Ideal for surface mount pick and place application  
Low profile package  
Built-in strain relief  
High surge capability  
High temperature soldering guaranteed  
260°C/10sec/at terminals  
Glass passivated chip  
Fast recovery time for high efficiency  
Halogen Free

### MECHANICAL DATA

Terminal: Solder plated, solderable per MIL-STD 750, method 2026  
Case: Molded with UL-94 class V-0 recognized Halogen Free Epoxy  
Polarity: color band denotes cathode



### MAXIMUM RATINGS AND ELECTRICAL CHARACTERISTICS

(single-phase, half-wave, 60HZ, resistive or inductive load rating at 25°C, unless otherwise stated)

	SYMBOL	GU3KR-B-E	units
Maximum Recurrent Peak Reverse Voltage	V <sub>rrm</sub>	800	V
Maximum RMS Voltage	V <sub>rms</sub>	560	V
Maximum DC blocking Voltage	V <sub>dc</sub>	800	V
Maximum Average Forward Rectified Current 3/8" lead length at T <sub>L</sub> = 75°C	I <sub>f(av)</sub>	3.0	A
Peak Forward Surge Current 8.3ms single half sine- wave superimposed on rated load	I <sub>fsm</sub>	100.0	A
Maximum Instantaneous Forward Voltage at rated forward current	V <sub>f</sub>	1.7	V
Maximum DC Reverse Current Ta = 25°C at rated DC blocking voltage Ta = 125°C	I <sub>r</sub>	10.0 500.0	μA μA
Maximum Reverse Recovery Time (Note 1)	T <sub>rr</sub>	75	nS
Typical Junction Capacitance (Note 2)	C <sub>j</sub>	50	pF
Typical Thermal Resistance (Note 3)	R <sub>th(jl)</sub>	18	°C/W
Storage and Operating Junction Temperature	T <sub>stg</sub> , T <sub>j</sub>	-50 to +150	°C

Note:

1. Reverse Recovery Condition I<sub>f</sub> = 0.5A, I<sub>r</sub> = 1.0A, I<sub>rr</sub> = 0.25A
2. Measured at 1.0 MHz and applied reverse voltage of 4.0Vdc
3. Thermal Resistance from Junction to terminal mounted on 7 × 7mm copper pad area

RATINGS AND CHARACTERISTIC CURVES GU3KR-B-E

Fig. 1 — Forward Current Derating Curve

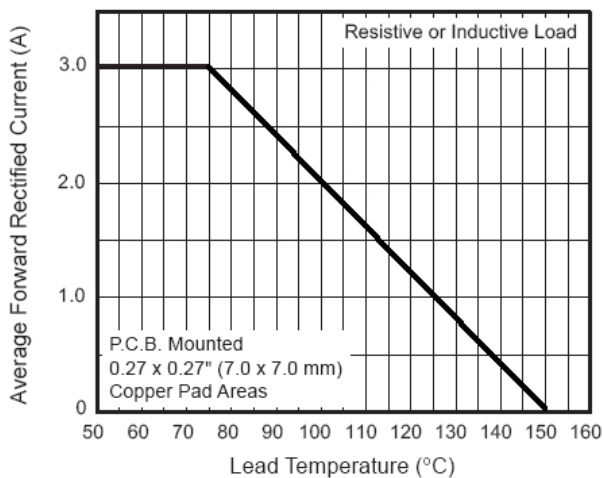


Fig. 2 — Maximum Non-Repetitive Peak Forward Surge Current

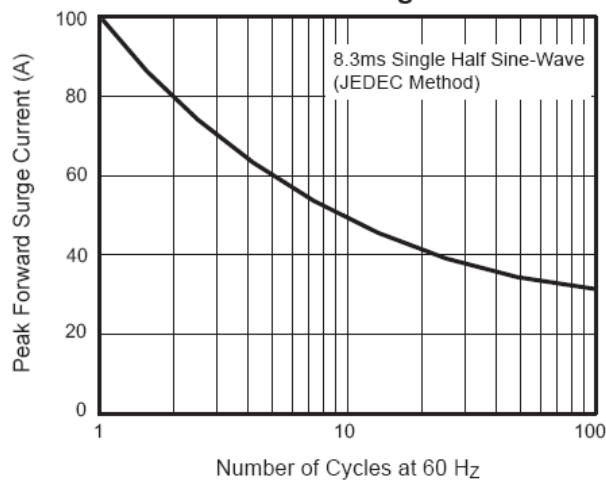


FIG. 3 - TYPICAL FORWARD CHARACTERISTICS

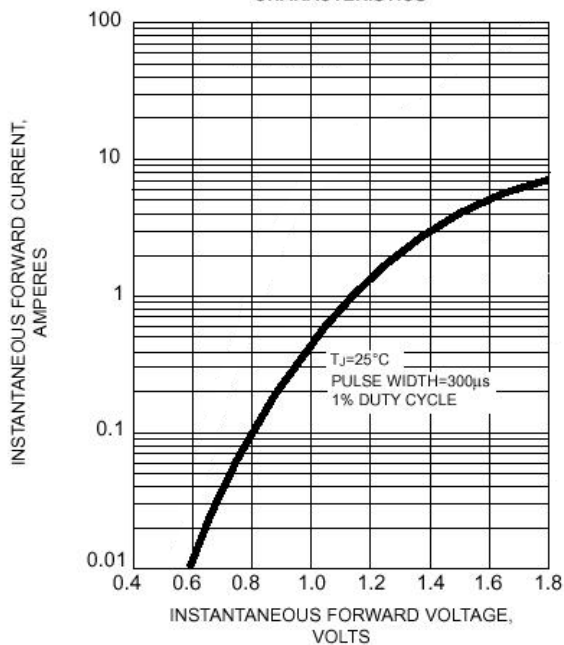


FIG. 4 - TYPICAL REVERSE LEAKAGE CHARACTERISTICS

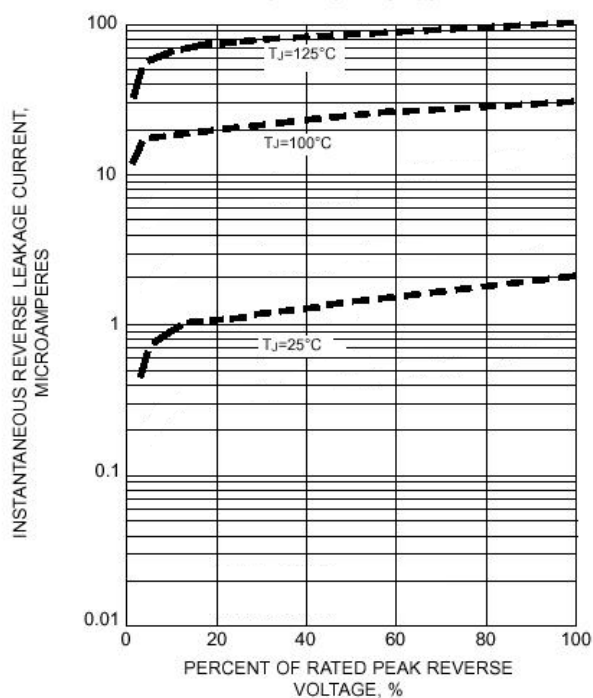


FIG. 5 - TYPICAL TRANSIENT THERMAL IMPEDANCE

